

Title (en)  
MICROMECHANICAL COMPONENT

Title (de)  
MIKROMECHANISCHES BAUELEMENT

Title (fr)  
COMPOSANT MICROMECHANIQUE

Publication  
**EP 1266229 A1 20021218 (DE)**

Application  
**EP 01915072 A 20010301**

Priority  
• DE 0100770 W 20010301  
• DE 10012960 A 20000316

Abstract (en)  
[origin: DE10012960A1] The component consists of a body (mass) secured to a substrate by a flexible mechanical structure. Provision is made to enable the spring constant of this structure to be adjusted in steps.

IPC 1-7  
**G01P 15/08**; **G01P 15/125**

IPC 8 full level  
**B81B 3/00** (2006.01); **G01P 15/08** (2006.01); **G01P 15/125** (2006.01)

CPC (source: EP US)  
**G01P 15/08** (2013.01 - EP US); **G01P 15/125** (2013.01 - EP US); **G01P 2015/0814** (2013.01 - EP US); **H01L 2924/0002** (2013.01 - EP US)

C-Set (source: EP US)  
**H01L 2924/0002** + **H01L 2924/00**

Designated contracting state (EPC)  
DE FR GB IT

DOCDB simple family (publication)  
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**DE 10012960 A 20000316**; DE 0100770 W 20010301; EP 01915072 A 20010301; JP 2001568095 A 20010301; US 23932702 A 20021227